BLF7G22L-200; BLF7G22LS-200 Power LDMOS transistor Rev. 5 — 1 September 2015

AMPLEON

Product data sheet

Product profile

1.1 General description

200 W LDMOS power transistor for base station applications at frequencies from 2110 MHz to 2170 MHz.

Typical performance Table 1.

Typical RF performance at $T_{case} = 25$ °C in a common source class-AB production test circuit.

Mode of operation	f	I _{Dq}	V _{DS}	P _{L(AV)}	Gp	η_{D}	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	2110 to 2170	1620	28	55	18.5	31	-31 <u>[1]</u>

^[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low R_{th} providing excellent thermal stability
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

RF power amplifiers for W-CDMA base stations and multi carrier applications in the 2110 MHz to 2170 MHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description		Simplified outline	Graphic symbol
BLF7G22	2L-200 (SOT502A)			
1	drain			,
2	gate			1
3	source	<u>[1]</u>		2
				3 sym112
BLF7G22	2LS-200 (SOT502B)			
1	drain			
2	gate		1 3	1
3	source	<u>[1]</u>		2 —
				-
				Syll112

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Packag	ge	
	Name	Description	Version
BLF7G22L-200	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A
BLF7G22LS-200	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	T_{case} = 80 °C; P_{L} = 80 W (CW); V_{DS} = 28 V; I_{Dq} = 1620 mA	0.26	K/W

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6. Characteristics

Table 6. Characteristics

 $T_j = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1.5 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	V_{DS} = 10 V; I_{D} = 150 mA	1.5	1.9	2.3	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	4.2	μА
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	42	50.8	-	Α
I _{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	420	nA
9 _{fs}	forward transconductance	V_{DS} = 10 V; I_{D} = 5.25 A	-	18.9	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 5.25 \text{ A}$	-	0.054	-	Ω

7. Test information

Table 7. Functional test information

Mode of operation: 2-carrier W-CDMA; PAR = 8.4 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1-64 DPCH; f_1 = 2112.5 MHz; f_2 = 2117.5 MHz; f_3 = 2162.5 MHz; f_4 = 2167.5 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 1620 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	55	-	W
Gp	power gain	$P_{L(AV)} = 55 W$	16.8	18.5	-	dB
RLin	input return loss	$P_{L(AV)} = 55 W$	-	-15	-6	dB
η_{D}	drain efficiency	$P_{L(AV)} = 55 W$	27	31	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 55 W$	-	-31	-25.5	dBc

7.1 Ruggedness in class-AB operation

The BLF7G22L-200 and BLF7G22LS-200 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Dq} = 1620 mA; P_L = 200 W (CW); f = 2110 MHz to 2170 MHz.

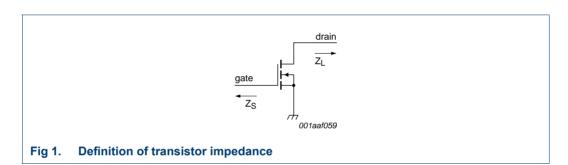
7.2 Impedance information

Table 8. Typical impedance

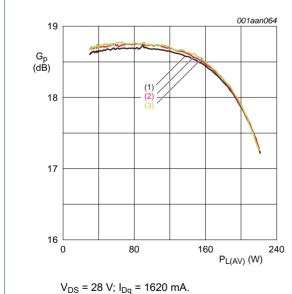
Measured load-pull data; $I_{Da} = 1620 \text{ mA}$; $V_{DS} = 28 \text{ V}$.

f	Z _S [1]	Z _L [1]
(MHz)	(Ω)	(Ω)
2050	1.05 – j4.04	2.04 – j1.28
2110	1.18 – j4.17	1.67 – j1.52
2140	1.32 – j4.68	1.67 – j1.52
2170	1.58 – j4.37	1.62 – j1.63
2230	2.55 – j5.14	1.51 – j1.83

[1] Z_S and Z_L defined in Figure 1.



7.3 1 Tone CW

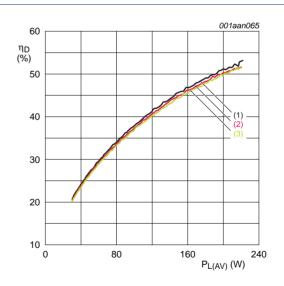


(1) f = 2110 MHz

(2) f = 2140 MHz

(3) f = 2170 MHz

Fig 2. Power gain as a function of average load power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1620 \text{ mA}.$

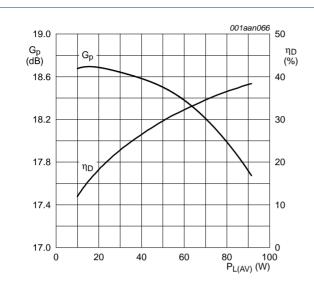
(1) f = 2110 MHz

(2) f = 2140 MHz

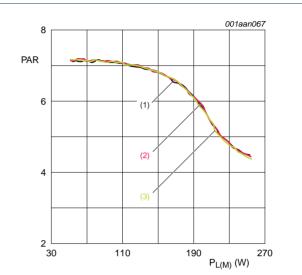
(3) f = 2170 MHz

Fig 3. Drain efficiency as a function of average load power; typical values

7.4 1-carrier W-CDMA



 V_{DS} = 28 V; I_{Dq} = 1620 mA; f = 2140 MHz; PAR = 7.2 dB at 0.01 % probability on the CCDF.

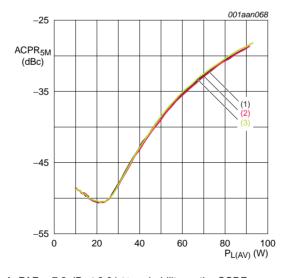


 V_{DS} = 28 V; I_{Dq} = 1620 mA; PAR = 7.2 dB at 0.01 % probability on the CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 4. Power gain and drain efficiency as functions of average load power; typical values



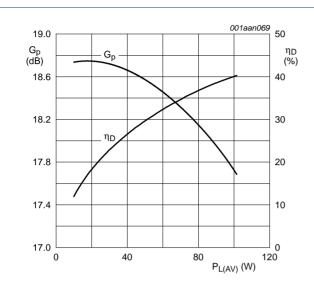


 V_{DS} = 28 V; I_{Dq} = 1620 mA; PAR = 7.2 dB at 0.01 % probability on the CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

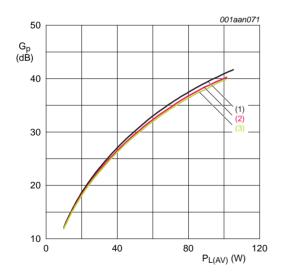
Fig 6. Adjacent power channel ratio (5 MHZ) as function of average load power; typical values

7.5 2-carrier W-CDMA



 V_{DS} = 28 V; I_{Dq} = 1620 mA; f = 2140 MHz; Channel Spacing = 5 MHz; PAR = 8.4 dB at 0.01 % probability on the CCDF.

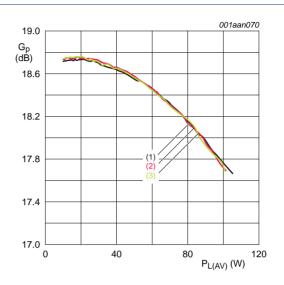
Fig 7. Power gain and drain efficiency as functions of average load power; typical values



 V_{DS} = 28 V; I_{Dq} = 1620 mA; Channel Spacing = 5 MHz; PAR = 8.4 dB at 0.01 % probability on the CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

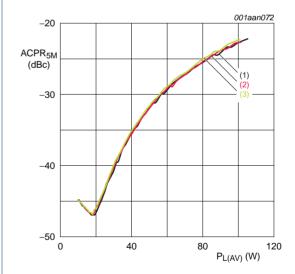
Fig 9. Drain efficiency as function of average load power; typical values



 V_{DS} = 28 V; I_{Dq} = 1620 mA; Channel Spacing = 5 MHz; PAR = 8.4 dB at 0.01 % probability on the CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 8. Power gain as a function of average load power; typical values



 V_{DS} = 28 V; I_{Dq} = 1620 mA; Channel Spacing = 5 MHz; PAR = 8.4 dB at 0.01 % probability on the CCDF.

- (1) f = 2110 MHz
- (2) f = 2140 MHz
- (3) f = 2170 MHz

Fig 10. Adjacent power channel ratio (5 MHZ) as function of average load power; typical values

7.6 Test circuit

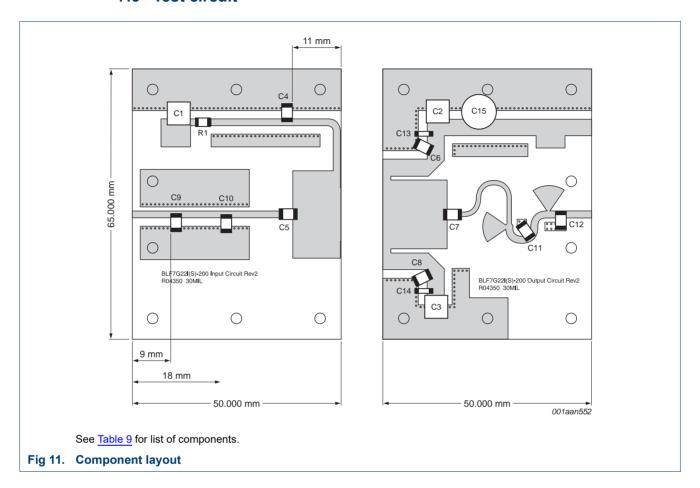


Table 9. List of components
See Figure 11 for component layout.

Component	Description	Value		Remarks
C1	multilayer ceramic chip capacitor	10 μF	[1]	TDK
C2, C3	multilayer ceramic chip capacitor	4.7 μF	[1]	TDK
C4, C5, C6, C7, C8	multilayer ceramic chip capacitor	22 pF	[2]	ATC100B
C9	multilayer ceramic chip capacitor	2.0 pF	[2]	ATC100B
C10	multilayer ceramic chip capacitor	2.1 pF	[2]	ATC100B
C11	multilayer ceramic chip capacitor	0.5 pF	[2]	ATC100B
C12	multilayer ceramic chip capacitor	0.9 pF	[2]	ATC100B
C13, C14	multilayer ceramic chip capacitor	330 nF	[1]	TDK
C15	electrolytic capacitor	470 μF; 63 V		
R1	chip resistor	10 Ω		Philips 1206

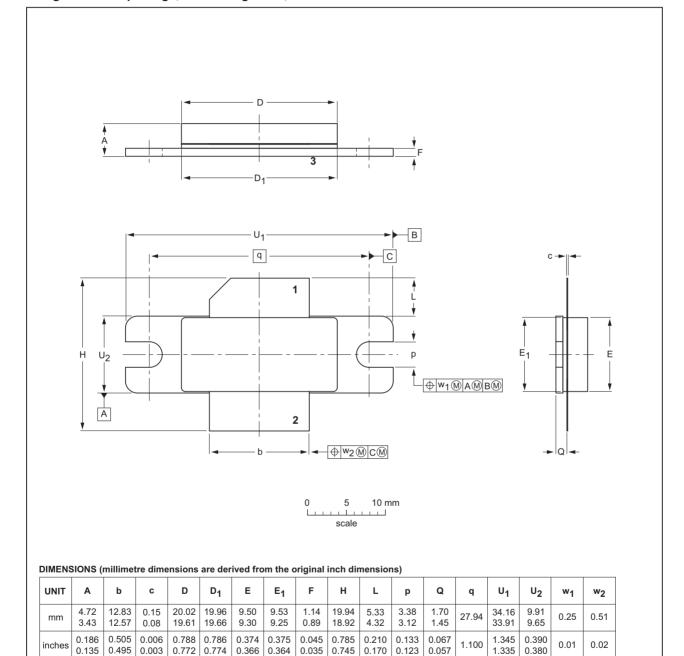
^[1] TDK or capacitor of same quality.

^[2] American Technical Ceramics type 100B or capacitor of same quality.

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

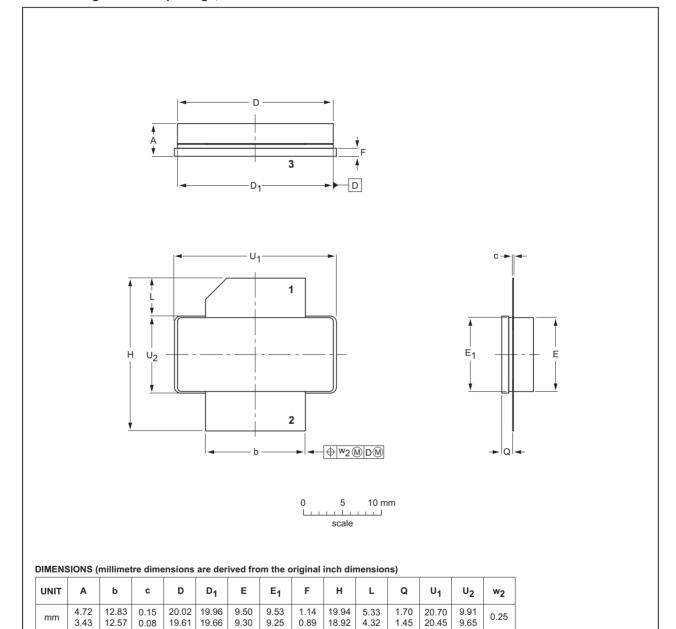


OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT502A					-03-01-10- 12-05-02

Fig 12. Package outline SOT502A

Earless flanged ceramic package; 2 leads

SOT502B



	OUTLINE REFERENCES EUROPEAN ISSUE DATE			VE	ERSION		I	EC		JEDI	EC		JEITA					PROJE	CTION	ISSUE DA	12
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0.045 | 0.785 | 0.210

0.067

0.815

0.390

0.374 0.375

Fig 13. Package outline SOT502B

0.186

SOT502B

0.006

0.788 0.786

0.505

07-05-09

12-05-02

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

10. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LDMOST	Laterally Diffused Metal Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
RF	Radio Frequency
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF7G22L-200_7G22LS-200#5	20150901	Product data sheet	-	BLF7G22L-200_7G22LS-200 v.4
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 			
BLF7G22L-200_7G22LS-200 v.4	20110722	Product data sheet	-	BLF7G22L-200_7G22LS-200 v.3
BLF7G22L-200_7G22LS-200 v.3	20110401	Preliminary data sheet	-	BLF7G22L-200_7G22LS-200 v.2
BLF7G22L-200_7G22LS-200 v.2	20101228	Preliminary data sheet	-	BLF7G22L-200_7G22LS-200 v.1
BLF7G22L-200_7G22LS-200 v.1	20100419	Objective data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet Qualification		This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

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Power LDMOS transistor

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